METHOD AND APPARATUS FOR SOLDER BALL MOUNTING

ABSTRACT

A template assembly comprising; a template for receiving solder balls; a reservoir housing for containing a plurality of solder balls, said reservoir housing arranged to move over said template and distribute the solder balls within said template and; a fluid interface device for providing a fluid interface between the template and reservoir housing.

Fig 1A



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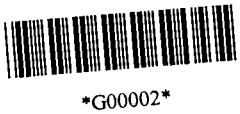

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